

### SCHOTTKY BARRIER RECTIFIERS

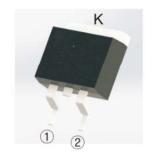
Reverse Voltage - 40 to 200 V

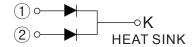
Forward Current - 20 A

#### **FEATURES**

- High current capability
- Low forward voltage drop
- Low power loss, high efficiency
- High surge capability
- High temperature soldering guaranteed
- Mounting position: any

## TO-263(D<sup>2</sup>PAK)





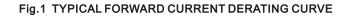
# MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS Ratings at 25°C ambient temperature unless otherwise specified

CHARACTERISTICS	SYMBOL	MBR2040CG	MBR2045CG	MBR2060CG	MBR20100CG	MBR20150CG	MBR20200CG	Units
Maximum Recurrent Peak Reverse Voltage	$V_{RRM}$	40	45	60	100	150	200	٧
Maximum RMS voltage	V <sub>RMS</sub>	28	31.5	42	70	105	140	٧
Maximum DC Blocking Voltage	V <sub>DC</sub>	40	45	60	100	150	200	V
Maximum Average Forward per diode Rectified Current per device	I <sub>F(AV)</sub>	10 20						Α
Peak Forward Surge Current,8.3ms Single Half Sine-wave Superimposed on Rated Load (JEDEC method) per diode	I <sub>FSM</sub>	150						А
Max Instantaneous Forward Voltage at 10 A DC Per leg	V <sub>F</sub>	0.70		0.75	0.85	0.90	0.92	V
Maximum DC Reverse Current $T_a = 25^{\circ}$ C at Rated DC Reverse Voltage $T_a = 125^{\circ}$ C	I <sub>R</sub>	0.1 0.05 20 20					mA	
Typical Junction Capacitance (1)	C <sub>j</sub>	600			400			pF
Typical Thermal Resistance (2)	$R_{\theta JA}$	45						°C/W
Operating Junction Temperature Range	Tj	-55 ~ +150           -55 ~ +17					+175	°C
Storage Temperature Range	T <sub>stg</sub>	-55 ~ +150           -55 ~ +1					+175	°C

<sup>( 1 )</sup> Measured at 1 MHz and applied reverse voltage of 4 V D.C

<sup>(2)</sup> P.C.B. mounted with 10cmX10cmX1mm copper pad areas.





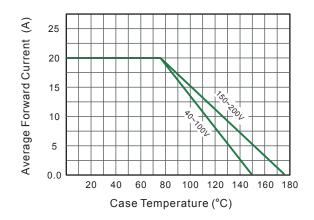


Fig.2 Typical Reverse Characteristics

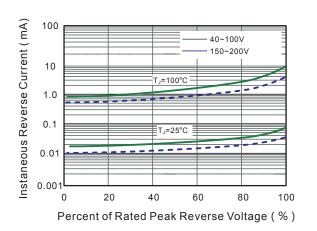


Fig.3 Typical Forward Characteristic(per leg)

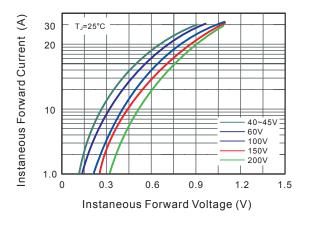


Fig.4 Typical Junction Capacitance

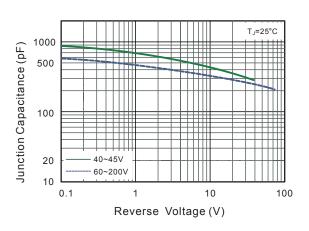


Fig.5 Maximum Non-Repetitive Peak Forward Surage Current

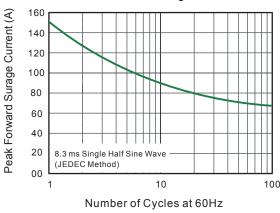
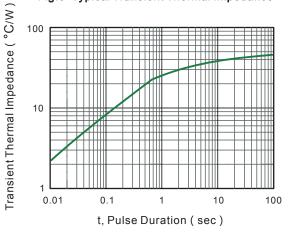
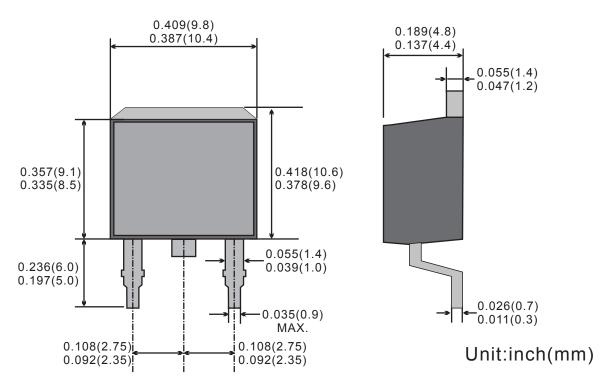


Fig.6- Typical Transient Thermal Impedance





## TO-263(D-P<sup>2</sup>AK) Package Outline Dimensions



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